



IEEE 2019 INTERNATIONAL 3D SYSTEMS  
INTEGRATION CONFERENCE  
October 8-10, 2019 Sendai, Japan  
*October 8 at Hotel Metropolitan Sendai*  
*October 9-10 at Miyagino Ward Cultural Center, Sendai*



## SPECIAL SESSION

## IEEE ELECTRONICS PACKAGING AWARD 2020

### Recipients Talk

**09:20-09:50, October 10, 2019 Paper ID-4088**

**TBA**

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### <Abstract>

TBA

### <CV>

1974 Received Ph.D. degrees in electronic engineering from Tohoku University, and He joined the Central Research Laboratory, Hitachi Ltd.

1985 Joined Xerox Palo Alto Research Center, California.

1988 Professor at Research Center for Integrated Systems, Hiroshima University.

1994 Professor in Department of Machine Intelligent and Systems Engineering, Department of Bioengineering and Robotics, and New Industry Creation Hatchery Center (NICHe), Tohoku University.

1998-2000 Director of Venture Business Laboratory in Tohoku University.

2008-2010 Distinguished Professor in Tohoku University.

National Medal with Purple Ribbon in Japan (2011), IEEE Jun-ichi Nishizawa Medal (2006), Award of Ministry of Education, Culture, Sports, Science and Technology (2001), IEEE Cleo Brunetti Award (1996), Okouchi Prize (1990) and so on.